

Who Needs an Electrical Back-Contact after All

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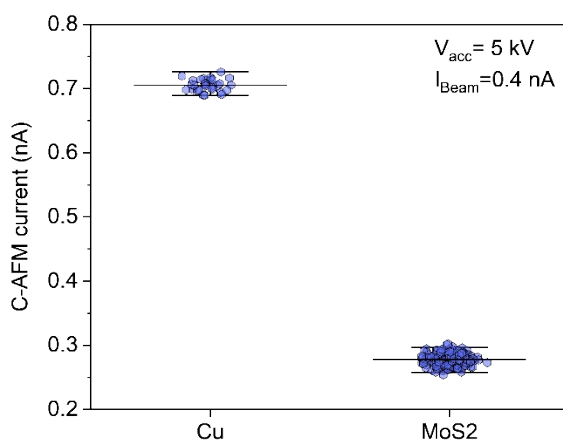


Figure S1. Detected C-AFM current upon e-beam irradiation on bulk Cu conductor and thin MoS₂/SiO₂/Si samples from the same distance of 100 μm. Cu conductor is 10 μm thick whereas MoS₂ has 3-4 monolayers, nearly 2 nm thin.

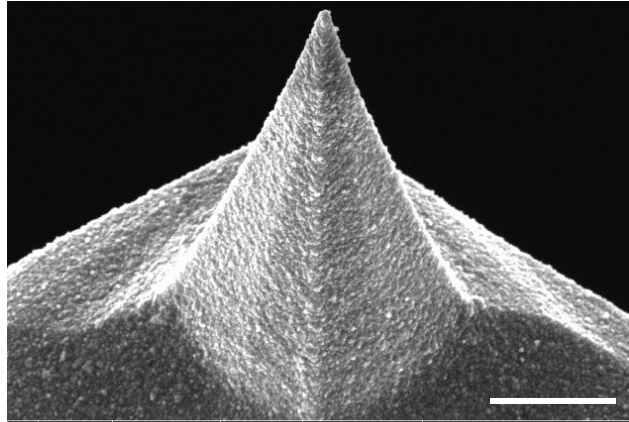


Figure S2. SEM image of a diamond-coated self-sensing probe. Scale bar is 2 μm.